### EMC Components

3-terminal filters Signal line MEM series



**公TDK** 

# MEM2012S type



#### FEATURES

- O Multilayer chip EMC filter.
- O Monolithic structure makes it highly reliable.
- O Closed magnetic circuit structure makes it possible to achieve high-density mounting without crosstalk.
- O Has sharp attenuation characteristics with excellent EMC suppression.
- Wide range of products compatible with passing frequencies and attenuating frequencies.
- T-type circuit is used.
- Operating temperature range: -40 to +85°C

#### APPLICATION

Noise removal from signal lines of data terminals, digital cameras, computers, game machines, flat TVs, etc.
 Application guides: <u>Smart phones/tablets</u>

#### PART NUMBER CONSTRUCTION

MEN	MEM 2012		12	S		25R0		Т		001	
Series na	ame		mensions <0.85 mm		internal de		equency Hz)	Packagi	ng style	Interna	al code

#### CHARACTERISTICS SPECIFICATION TABLE

Cutoff frequency	Insertion loss	Rated voltage	Rated current	Part No.
(MHz)	(dB)	(V)max.	(mA)max.	
25	30[70MHz to 2GHz]	10	100	MEM2012S25R0T001
35	30[90MHz to 2GHz]	10	100	MEM2012S35R0T001
50	30[200MHz to 2GHz]	10	100	MEM2012S50R0T001
100	30[400MHz to 2GHz]	10	250	MEM2012S101RT001
200	30[530MHz to 2GHz]	10	250	MEM2012S201RT001

#### Measurement equipment

Measurement item	Product No.	Manufacturer
Frequency characteristics	N5230C	Keysight Technologies

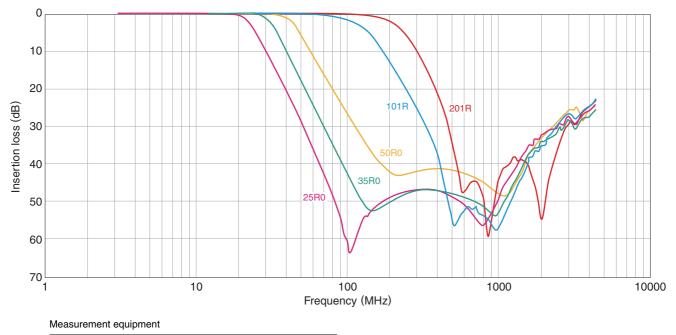
\* Equivalent measurement equipment may be used.



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# MEM2012S type

#### ■ INSERTION LOSS VS. FREQUENCY CHARACTERISTICS



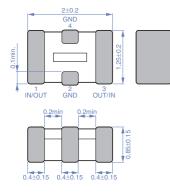
Product No.	Manufacturer				
N5230C	Keysight Technologies				

\* Equivalent measurement equipment may be used.

Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use.
(2/4)
Please note that the contents may change without any prior notice due to reasons such as upgrading.
20190207

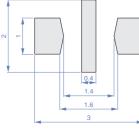
## MEM2012S type

### SHAPE & DIMENSIONS

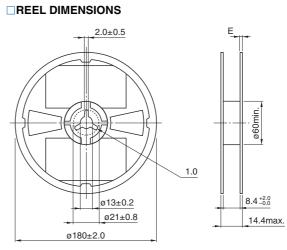


Dimensions in mm

#### RECOMMENDED LAND PATTERN

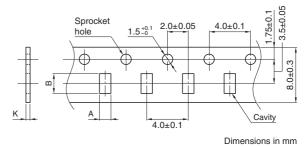


PACKAGING STYLE

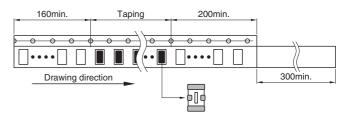


Dimensions in mm





Κ Туре В А MEM2012S 1.55±0.20 2.30±0.20 1.10max.



Dimensions in mm

#### **PACKAGE QUANTITY**

Package quantity	4,000 pcs/reel
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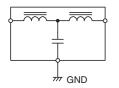
#### TEMPERATURE RANGE, INDIVIDUAL WEIGHT

tem	perature range	temperature range*	weight			
	-40 to +85 °C -40 to +85 °C 8 mg					

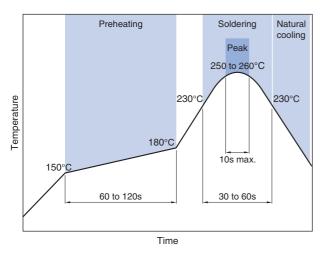
The storage temperature range is for after the assembly.

Dimensions in mm

### **CIRCUIT DIAGRAM**



#### RECOMMENDED REFLOW PROFILE



A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading. (3/4)

## **REMINDERS FOR USING THESE PRODUCTS**

Before using these products, be sure to request the delivery specifications.

## SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

The storage period is less than 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less). If the storage period elegand, the coldering of the terminal elegandee may deteriorate.					
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.					
O Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).					
Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.					
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.					
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.					
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.					
<ul> <li>Carefully lay out the coil for the circuit board design of the non-magnetic shield type.</li> <li>A malfunction may occur due to magnetic interference.</li> </ul>					
$\bigcirc$ Use a wrist band to discharge static electricity in your body through	the grounding wire.				
O Do not expose the products to magnets or magnetic fields.					
O Do not use for a purpose outside of the contents regulated in the de	elivery specifications.				
<ul> <li>The products listed on this catalog are intended for use in general ment, home appliances, amusement equipment, computer equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirement ity require a more stringent level of safety or reliability, or whose fail person or property.</li> <li>If you intend to use the products in the applications listed below or not fath in the page parts of the products in the applications listed below or not fath in the page.</li> </ul>	nent, personal equipment, office equipment, measurement equip- n. hts of the applications listed below, whose performance and/or qual- lure, malfunction or trouble could cause serious damage to society,				
set forth in the each catalog, please contact us.					
<ol> <li>(1) Aerospace/aviation equipment</li> <li>(2) Transportation equipment (cars, electric trains, ships, etc.)</li> <li>(3) Medical equipment</li> <li>(4) Power-generation control equipment</li> <li>(5) Atomic energy-related equipment</li> <li>(6) Seabed equipment</li> <li>(7) Transportation control equipment</li> </ol>	<ul> <li>(8) Public information-processing equipment</li> <li>(9) Military equipment</li> <li>(10) Electric heating apparatus, burning equipment</li> <li>(11) Disaster prevention/crime prevention equipment</li> <li>(12) Safety equipment</li> <li>(13) Other applications that are not considered general-purpose applications</li> </ul>				
When designing your equipment even for general-purpose application tection circuit/device or providing backup circuits in your equipment.	is, you are kindly requested to take into consideration securing pro-				

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Authorized Distributor

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 MEM2012S25R0T
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 MEM2012S50R0T
 MEM2012S101RT
 MEM2012S201R0T
 MEM2012S201RT

 MEM2012S35R0T
 MEM2012S101RT
 MEM2012S201R0T
 MEM2012S201RT